

#### **DATA SHEET**

# **SKY65943-11: GNSS Low-Noise Amplifier Front-End Module with Integrated Pre-Filter and Post-Filter**

## **Applications**

- Wearables
- Action cameras
- Drones
- · Personal navigation devices
- · GNSS radio receivers

### **Features**

• Small signal gain: 16 dB

• Out-of-band P1dB: +6 dBm

• Out-of-band rejection: +80 dBc, 1627 to 1660 MHz

• Low noise figure: 1.7 dB

• Low current consumption: 2.9 mA @ 1.8 V

ullet Input/output impedance internally matched to 50  $\Omega$ 

• Single DC supply: 1.62 to 3.3 V

Minimum number of external SMT devices required

 Small MCM (10-pin, 2.5 x 2.5 mm) package (MSL3, 260 °C per JEDEC J-STD-020)



Skyworks Green<sup>TM</sup> products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*<sup>TM</sup>, document number SQ04-0074.

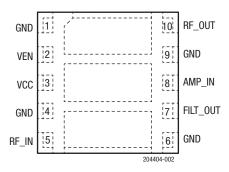


Figure 2. SKY65943-11 Pinout (Top View)

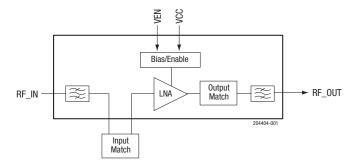


Figure 1. SKY65943-11 Block Diagram

## **Description**

The SKY65943-11 is a front-end module (FEM) with an integrated low-noise amplifier (LNA) and pre-filter and post-filter designed for Global Navigation Satellite System (GNSS) receiver applications. The device provides high gain, excellent out-of-band rejection, and low noise figure. The pre-filter and post-filter provide low in-band insertion loss and excellent rejection for the cellular, PCS, and WLAN frequency bands. Output matching components are embedded inside the device. Only one external input matching inductor is required.

The SKY65943-11 is optimized to operate at 1559 to 1606 MHz, which makes it ideal for GPS/GLONASS/Galileo/Compass/QZSS radio receiver applications.

The SKY65943-11 uses surface-mount technology (SMT) in the form of a  $2.5 \times 2.5$  mm Multi-Chip Module (MCM) package, which allows for a highly manufacturable and low-cost solution.

A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

**Table 1. SKY65943-11 Signal Descriptions** 

Pin	Name	Description	Pin	Name	Description
1	GND	Ground	6	GND	Ground
2	VEN	LNA enable	7	FILT_OUT	Filter output
3	VCC	LNA power supply	8	AMP_IN	LNA input
4	GND	Ground	9	GND	Ground
5	RF_IN	RF input	10	RF_OUT	RF output

## **Technical Description**

#### **LNA Enable**

The VEN signal (pin 2) enables or disables the LNA. A logic high signal powers on the LNA, and a logic low signal powers off the device.

# **Electrical and Mechanical Specifications**

The absolute maximum ratings of the SKY65943-11 are provided in Table 2. The recommended operating conditions are specified in Table 3, and electrical specifications are provided in Tables 4 and 5.

Table 2. SKY65943-11 Absolute Maximum Ratings<sup>1</sup>

Parameter	Symbol	Minimum	Maximum	Units	
RF input power	Pin		+10	dBm	
Supply voltage	Vcc	0	3.4	V	
Storage temperature	Тѕтс	-55	+150	°C	
Junction temperature	TJ		+150	°C	
Electrostatic discharge:	ESD				
Human Body Model (HBM), Class 1A			250	V	

Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

**ESD HANDLING**: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device.

This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection.

Industry-standard ESD handling precautions should be used at all times.

**Table 3. SKY65943-11 Recommended Operating Conditions** 

Parameter	Symbol	Min	Тур	Max	Units	
Frequency	f	1559	1575	1606	MHz	
Supply voltage	Vcc	1.62		3.3	V	
LNA enable:						
Enable (high)	LNAENABLE	Vcc - 0.3		Vcc	V	
Disable (low)	LNADISABLE		0	0.3	V	
Case temperature	Tc	-40	+25	+85	°C	

Table 4. SKY65943-11 Electrical Specifications  $^1$  (Vcc = 1.8 V, Ven = 1.8 V, f = 1575 MHz, Tc = +25 °C, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
		P <sub>IN</sub> = -30 dBm:				
Small signal gain	IS21I	@ 1559 MHz @ 1575 MHz @ 1606 MHz	12 13.5 12	15 15 15		dB dB dB
Noise figure	NF	@ 1559 MHz @ 1575 MHz @ 1606 MHz		2.2 1.7 2.0	2.6 2.0 2.4	dB dB dB
In-band third order input intercept point	IIP3	f1 = 1575 MHz @ PIN = -30 dBm f2 = 1576 MHz @ PIN = -30 dBm		-7		dBm
In-band 1 dB input compression point	IP1dB			-13.5		dBm
Out of hand talk innut communication point	00B_IP1dB	f_00B = 1627 MHz, IP1dB@ f=1575 MHz	6			dBm
Out-of-band 1dB input compression point		f_00B = 1540 MHz, IP1dB@ f=1575 MHz	6			dBm
Reverse isolation	IS12I	P <sub>IN</sub> = -30 dBm	30	38		dB
Input return loss	IS11I	P <sub>IN</sub> = -30 dBm		10		dB
Output return loss	IS22I	P <sub>IN</sub> = -30 dBm		13		dB
Supply current	Icc	No RF		2.9	4.0	mA
Shutdown current	ILEAK	No RF, Ven = 0 V		0.1	1	μА
Out-of-band rejection	00B	PIN = 0 dBm (in-band referred):  @ 10 to 300 MHz @ 300 to 700 MHz @ 700 to 1525 MHz @ 1525 to 1540 MHz @ 1627 to 1660 MHz @ 1660 to 2500 MHz @ 2500 to 6000 MHz		+80 +90 +85 +60 +80 +75 +65		dBc dBc dBc dBc dBc dBc dBc
LNA turn-on time	ton	$P_{IN} = -30$ dBm, $V_{CC} = 1.8$ V, 50% of Venable to 90% final RF power		1	1.5	μS
LNA turn-off time	toff	$PIN = -30 \text{ dBm, } V_{CC} = 1.8 \text{ V}, 50\% \text{ of}$ Venable to 10% final RF power		0.1	0.2	μS

<sup>1</sup> Performance is guaranteed only under the conditions listed in this table.

Table 5. SKY65943-11 Electrical Specifications  $^1$  (Vcc = 2.8 V, Ven = 2.8 V, f = 1575 MHz, Tc = +25 °C, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
		PIN = -30 dBm:				
Small signal gain	IS21I	@ 1559 MHz @ 1575 MHz @ 1606 MHz	13.5 14.5 13.0	16 16 15.5		dB dB dB
Noise figure	NF	@ 1559 MHz @ 1575 MHz @ 1606 MHz		2.2 1.7 2.0	2.6 2.0 2.4	dB dB dB
In-band third order input intercept point	IIP3	f1 = 1575 MHz @ PiN = -30 dBm f2 = 1576 MHz @ PiN = -30 dBm		-7		dBm
In-band 1 dB input compression point	IP1dB			-13.0		dBm
0.11.11.11.11.11.11.11.11.11.11.11.11.11	000 10440	f_00B = 1627 MHz, IP1dB@ f=1575 MHz	6			dBm
Out-of-band 1dB input compression point	00B_IP1dB	f_00B = 1540 MHz, IP1dB@ f=1575 MHz	6			dBm
Reverse isolation	IS12I	PIN = -30 dBm		40		dB
Input return loss	IS11I	PIN = -30 dBm		12		dB
Output return loss	IS22I	PIN = -30 dBm		18		dB
Supply current	ICC	No RF		3	4.5	mA
Shutdown current	ILEAK	No RF, Ven = 0 V		0.1	1	μА
Out-of-band rejection	00B	P <sub>IN</sub> = 0 dBm (in-band referred):  @ 10 to 300 MHz @ 300 to 700 MHz @ 700 to 1525 MHz @ 1525 to 1540 MHz @ 1627 to 1660 MHz @ 1660 to 2500 MHz @ 2500 to 6000 MHz		+80 +90 +85 +60 +80 +75 +65		dBc dBc dBc dBc dBc dBc dBc
LNA turn-on time	Ton	$P_{IN} = -30 \text{ dBm}, V_{CC} = 2.8 \text{ V}, 50\% \text{ of}$ Venable to 90% final RF power		1	1.5	μS
LNA turn-off time	T <sub>OFF</sub>	PIN = -30 dBm, $Vcc = 2.8$ V, 50% of Venable to 10% final RF power		0.1	0.2	μS

<sup>1</sup> Performance is guaranteed only under the conditions listed in this table.

## **Evaluation Board Description**

The SKY65943-11 Evaluation Board is used to test the performance of the SKY65943-11 LNA. An assembly drawing for the Evaluation Board is shown in Figure 3. The Evaluation Board schematic diagram is shown in Figure 4. Table 6 provides the Bill of Materials (BOM) list for Evaluation Board components.

## **Package Dimensions**

The PCB layout footprint for the SKY65943-11 is provided in Figure 5. Typical part markings are shown in Figure 6. Package dimensions are shown in Figure 7, and tape and reel dimensions are provided in Figure 8.

# **Package and Handling Information**

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY65943-11 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *PCB Design & SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

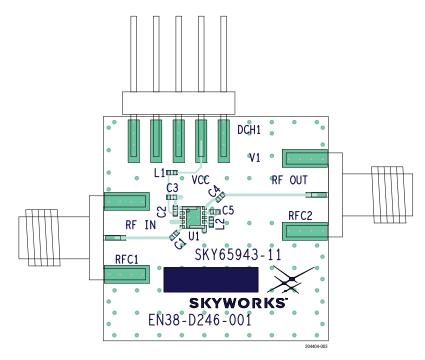
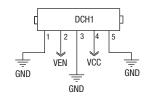


Figure 3. SKY65943-11 Evaluation Board Assembly Diagram



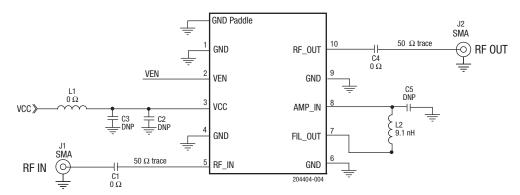
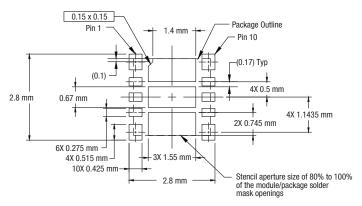


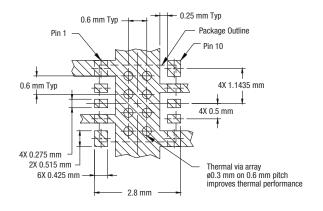
Figure 4. SKY65943-11 Evaluation Board Schematic

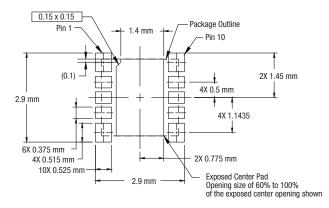
**Table 6. SKY65943-11 Evaluation Board Bill of Materials** 

Component	Size	Value	Manufacturer	Mfr Part Number
L1 (optional)	0402	0 Ω	Panasonic	ERJ-2GE0R00X
L2	0402	9.1 nH	Murata	LQW15AN9N1J00D
C1, C4	0402	0Ω	Panasonic	ERJ-2GE0R00X
C2, C3, C5	0402	DNP		DNP



## Stencil Aperture





Solder Mask Opening

## Metallization

#### Notes:

- 1. All dimensions are in millimeters, unless otherwise specified.
- Thermal vias should be resin filled and capped in accordance with IPC-4761Type VII vias. Recommended Cu thickness is 30 to 35 μm.

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Figure 5. SKY65943-11 PCB Layout Footprint

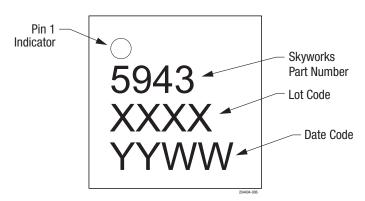
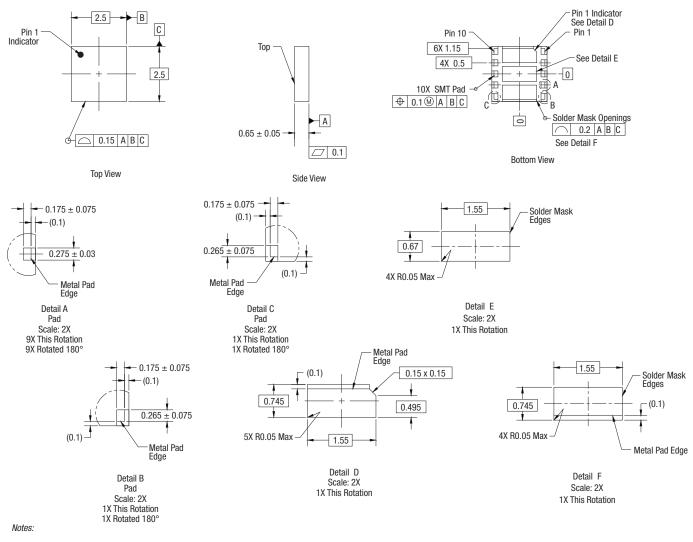


Figure 6. Typical Part Markings (Top View)



1. Dimensions are in millimeters.

2. Dimensions and tolerances according to ASME Y14.5M-1994. 3. Pad definitions per details on drawing.

Figure 7. SKY65943-11 Package Dimensions

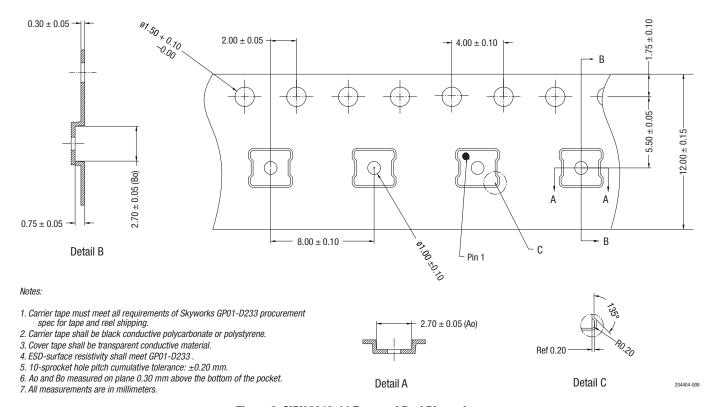


Figure 8. SKY65943-11 Tape and Reel Dimensions